

October 20, 2025

To Whom It May Concern,

Corporate Name: TechnoPro Holdings, Inc.
Representative: Takeshi Yagi, President, Representative Director & CEO
(Code:6028, TSE Prime Market)
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Notice Regarding Implementation of Procedures for Early Redemption of Corporate Bonds

As stated in the "Notice Regarding Consideration on Early Redemption of Corporate Bonds" disclosed on October 1, 2025, the Company has been considering the early redemption of the TechnoPro Holdings, Inc. 2nd Series Unsecured Straight Bonds (with inter-bond pari passu clause) (the "Bonds"). At the Board of Directors meeting dated today, the Company resolved to implement the necessary procedures to amend the terms of the Bonds in order to proceed with early redemption. These procedures include convening a bondholders' meeting and other actions required to amend the bond terms. Further details are provided below.

1. Amendment to the Terms of the Bonds

The Company plans to amend the redemption date of the Bonds to December 30, 2025 (the "New Redemption Date") and revise the redemption amount to 100.164286 yen per 100 yen of face value. This amount is calculated by adding the amount equivalent to the interest for the period from the day immediately following the New Redemption Date to the original redemption date to the original redemption amount. The interest accruing from October 27, 2025 to the New Redemption Date will be paid on the New Redemption Date, and the new redemption amount of the Bonds will be redeemed in full on the same date.

2. Scheduled Date for the Bondholders' Meeting

The bondholders' meeting is scheduled to be held on November 20, 2025.

Please note that bondholders intending to exercise their voting rights at the bondholders' meeting must obtain a certificate under Article 86 of the Act on Book-Entry Transfer of Corporate Bonds and Shares (the "Act") and submit it to the Company no later than one week prior to the date of the bond meeting. This certificate is to be issued by the relevant upper-tier institution pursuant to Article 86, Paragraph 3 of the Act and certifies the matters listed in Article 68, Paragraph 3 of the Act in relation to the Bonds.

Further details will be announced promptly on the Company's website and via electronic public notice once determined.

Note on translation

This document is provided for informational purposes only. If there are any discrepancies between this and the original, the original Japanese document prevails.